UMENTS Data sheet acquired from Harris Semiconductor SCHS082C - Revised October 2003

CMOS 8-Bit Priority Encoder

High-Voltage Types (20-Volt Rating)

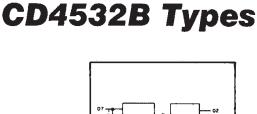
CD4532B consists of combinational logic that encodes the highest priority input (D7-D0) to a 3-bit binary code. The eight inputs, D7 through D0, each have an assigned priority; D7 is the highest priority and D0 is the lowest. The priority encoder is inhibited when the chip-enable input El is low. When E₁ is high, the binary representation of the highest-priority input appears on output lines Q2-Q0, and the group select line GS is high to indicate that priority inputs are present. The enable-out (EO) is high when no priority inputs are present. If any one input is high, ${\rm E}_{\rm O}$ is low and all cascaded lower-order stages are disabled.

The CD4532B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Features:

- Converts from 1 of 8 to binary
- Provides cascading feature to handle any number of inputs
- Group select indicates one or more priority inputs
- Standardized, symmetrical output characteristics
- = 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin (full-package-temperature rance):
 - 0.5 V at V_{DD} = 5 V

 - 1.5 V at $V_{DD} = 10 V$ 1.5 V at $V_{DD} = 15 V$
- = 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"
- Applications:
- Priority encoder
- Binary or BCD encoder (keyboard encoding)
- Floating point arithmetic



SELECT

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

FUNCTIONAL DIAGRAM

9205-26360

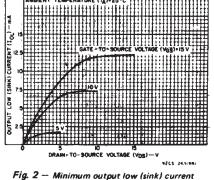
| Characteristic | Min. | Max | Units |
|---|------|-----|-------|
| Supply Voltage Range (for T _A = | 3 | 18 | v |
| Full Package Temp. Range) | | | |

MAXIMUM RATINGS, Absolute-Maximum Values:

VOLTAGE (VDS)-V Fig. 1 — Typical output low (sink) current

characteristics.

..... N.







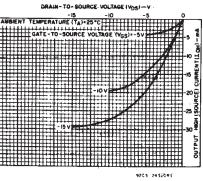
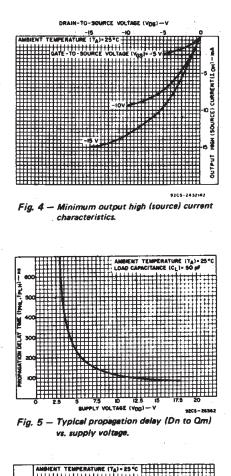


Fig. 3 - Typical output high (source) current characteristics.

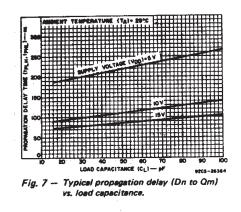
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STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER- | CONE | DITION | IS | LIMITS AT INDICATED TEMPERATURES (°C) | | | | | | | UNITS | | |
|-------------------------------------|----------|--------|-----|---------------------------------------|-------|-------|-------|-------|-------------------|---------------|---------|--|--|
| ISTIC | vo | VIN | VDD | | | · | | | +25 | | UNITS | | |
| | (V) | (V) | (V) | 55 | -40 | +85 | +125 | Min. | Тур. | Max. | | | |
| Quiescent Device | - | 0,5 | 5 | 5 | 5 | 150 | 150 | 1 | 0.04 | 5 | | | |
| Current, | - | 0,10 | 10 | 10 | 10 | 300 | 300 | | 0.04 | 10 | μA | | |
| IDD Max. | - | 0,15 | 15 | 20 | 20 | 600 | 600 | - | 0.04 | 20 | μΑ | | |
| | | 0,20 | 20 | 100 | 100 | 3000 | 3000 | - | 0.08 | 100 | | | |
| Output Low | 0.4 | 0,5 | 5 | 0.64 | 0.61 | 0.42 | 0.36 | 0.51 | 1 | - | | | |
| (Sink) Current | 0.5 | 0,10 | 10 | 1.6 | 1.5 | 1.1 | 0.9 | 1.3 | 2.6 | | ÷ 4 | | |
| IOL Min. | 1.5 | 0,15 | 15 | 4.2 | 4 | 2.8 | 2.4 | 3.4 | 6.8 | - | | | |
| Output High | 4.6 | 0,5 | 5 | -0.64 | -0.61 | -0.42 | -0.36 | -0.51 | -1 | - | mA | | |
| (Source) | 2.5 | 0,5 | 5 | -2 | -1.8 | -1.3 | -1.15 | -1.6 | -3.2 | . 7 | | | |
| Current, | 9.5 | 0,10 | 10 | -1.6 | -1.5 | -1.1 | -0.9 | -1.3 | -2.6 | 1 | н. 1 | | |
| IOH Min. | 13.5 | 0,15 | 15 | -4.2 | -4 | -2.8 | -2.4 | -3.4 | -6.8 | - | | | |
| Output Voltage: | _ | 0,5 | 5 | | 0 | .05 | | | 0 | 0.05 | | | |
| Low-Level, VOL Max. | - | 0,10 | 10 | | 0 | .05 | | _ | 0 | 0.05 | | | |
| VUL Wax. | - | 0,15 | 15 | | 0 | .05 | | - | 0 | 0.05 | v | | |
| Output Voltage: | - | 0,5 | 5 | | 4 | .95 | | 4.95 | 5 | - | • | | |
| High-Level, | | 0,10 | 10 | | 9 | .95 | | 9.95 | 10 | - | | | |
| VOH Min. | - | 0,15 | 15 | | 14 | 1.95 | | 14.95 | 15 | - | | | |
| Input Low | 0.5, 4.5 | | 5 | | | 1 | | - | - | 1.5 | | | |
| Voltage, | 1, 9 | · | 10 | | 2 | .5 | | - | - | 3 | | | |
| VIL Max.* | 1.5,13.5 | - | 15 | | | 3 | | - | - | 4 | v | | |
| Input High Voltage, VIH Min.* | 0.5, 4.5 | - | 5 | | | 4 | | 3.5 | - | — | ľ | | |
| | 1, 9 | | 10 | | 7 | .5 | | 7 | _ | | | | |
| | 1.5,13.5 | - | 15 | | 1 | 2 | | 11 | — | — | | | |
| Input Current IIN Max. | | 0,18 | 18 | ±0.1 | ±0.1 | ±1 | ±1 | - | ±10 ⁻⁵ | ±0.1 | μA | | |



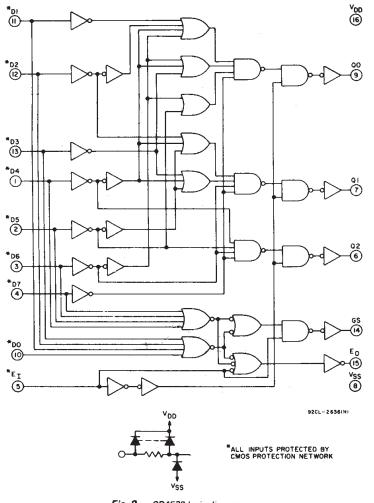
191 H *One input is tested at a time; other inputs should be at V_{DD} or V_{SS} . For testing all inputs at V_{IL} and V_{IH} levels, THE (PHIL VE I AV LOAD CAL ACITANCE (CL) --- PF 92CS-26363 Fig. 6 - Typical propagation delay (E; to GS, E; to E) vs. load capacitance.

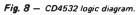


use 20%/80% V_{DD}.

DYNAMIC ELECTRICAL CHARACTERISTICS at TA=25°C; CL=50 pF, Input t_r, t_f = 20 ns, RL=200 K Ω

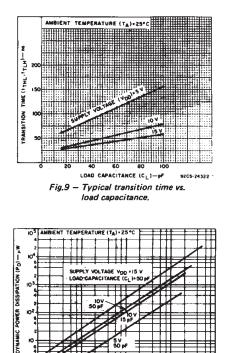
| CHARACTERISTIC | TEST CONDITIONS | LIN | UNITS | | |
|-----------------------------------|-----------------|------|-------|-------|--|
| | VOLTS | TYP. | MAX. | | |
| Propagation Delay Time tPHL, tPLH | 5 | 110 | 220 | | |
| EI to EO, EI to GS | 10 | 55 | 110 | | |
| | 15 | 45 | 85 | | |
| | 5 | 170 | 340 | | |
| Et to Qm, Dn to GS | 10 | 85 | 170 | ns | |
| | 15 | 65 | 125 | · · · | |
| | 5 | 220 | 440 | | |
| Dn to QM | 10 | 110 | 220 | | |
| | 15 | 85 | 160 | ·~ . | |
| | 5 | 100 | 200 | | |
| Transition Time tTHL, tTLH | 10 | 50 | 100 | ns | |
| | 15 | 40 | 80 | • | |
| Input Capacitance CIN | Any Input | 5 | 7.5 | pF | |



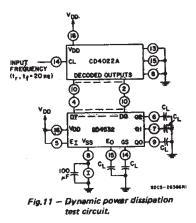


| TRU | | |
|-----|--|--|
| | | |
| | | |

| Input | | | | | | | | C | Dutput | | | | |
|-------------------------------|----|------------|----|----|----|----|------------|-----|--------|--------|----|----|----|
| ε _l | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | GS | 02 | 01 | Q0 | EO |
| 0 | X | X | X | X | X | X | X | X | 0 | 0 | 0 | 0 | 0 |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| 1 | 1 | X . | X | X | X | X | X | Х | 1 | 1 | 1 | 1 | 0 |
| 1 | 0 | 1 | X | X | X | X | X | X | 1 | 5 T.J. | 1 | 0 | 0 |
| 1 | 0 | σ | 1 | X | X | X | X | X | 1 | 1 | 0 | 1 | 0 |
| 1 | 0 | 0 | 0 | 1 | X | x | X 1 | х | 1 | 1 | 0 | 0 | 0 |
| 1 | 0 | 0 | 0 | 0 | 1 | X | X | Х | 1 | 0 | 1 | 1 | 0 |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 | X | x | 1 | 0 | 1 | 0 | 0 |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | х | 1 | 0 | 0 | 1 | 0 |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| X = Don't Care Logic 1 ≡ High | | | | | | | | Log | ic 0 ≡ | Low | | | |



3



FREQUENCY (1)

Fig. 10 - Typical dynamic power dissipation vs. frequency.

k Hz

9205-26365

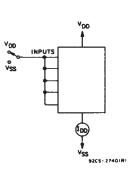


Fig. 12 - Quiescent device current test circuit.

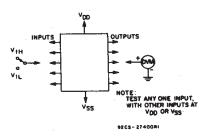


Fig. 13 – Input voltage test circuit.

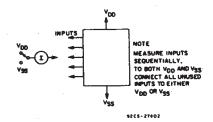
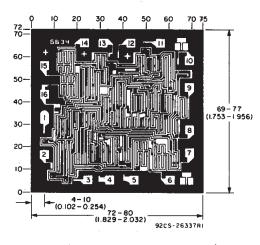


Fig. 14 - Input current test circuit.



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch) .

Dimensions and pad layout for CD4532BH.

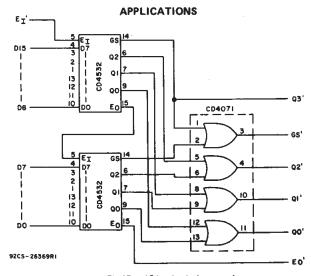
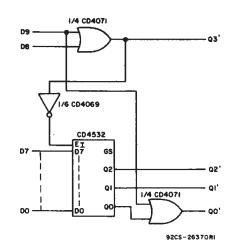


Fig. 15 — 16-level priority encoder.





| | Input | | | | | | | | | | Out | tput | | |
|-----|-------|------------------------|-----|----|----|-----|------------|----|----|----|----------|------|-----|------|
| D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | DO | GS | σ3. | Q2' | 01' | 00' |
| 1 | х | X | X | X | X | X | X | х | X | 0 | 1 | 0 | 0 | 1 |
| 0 | 1 | X | X. | X | X | X | X | X | X | 0 | 1 | 0 | 0 | 0 |
| 0 | 0 | 1 | X | X | X | X | X | X | X | 1- | 0 | 1 | 1 | 1 |
| 0 | 0 | 0 | 1 1 | X | X | X | X | X | X | 1 | 0 | 1 | 1 | ÷ 0. |
| 0 | 0 | 0 | 0 | 1 | X | X I | X | X | X | 1 | 0 | 1 | 0 | 1 |
| 0 | 0 | 0 | 0 | 0 | 1 | X | X - | X | X | 1 | 0 | 1 | 0 | 0 |
| 0 | 0 | 0 | 0 | 0 | 0 | - 1 | X | X | X | 1 | 0. | 0 | 1 | 1 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | X | X | 1 | . 0. | 0 | 1 | 0 |
| 0 | 0 | 0 | 0 | 0. | 0 | .0 | 0 | 1 | X | 1 | 0 | 0 | 0 | 1 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| X = | Don | 't Care Logic 1 ≡ High | | | | | | | | L | ogic O I | ≣.Lo | | |

Fig.16 - 0-to-9 keyboard encoder.

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

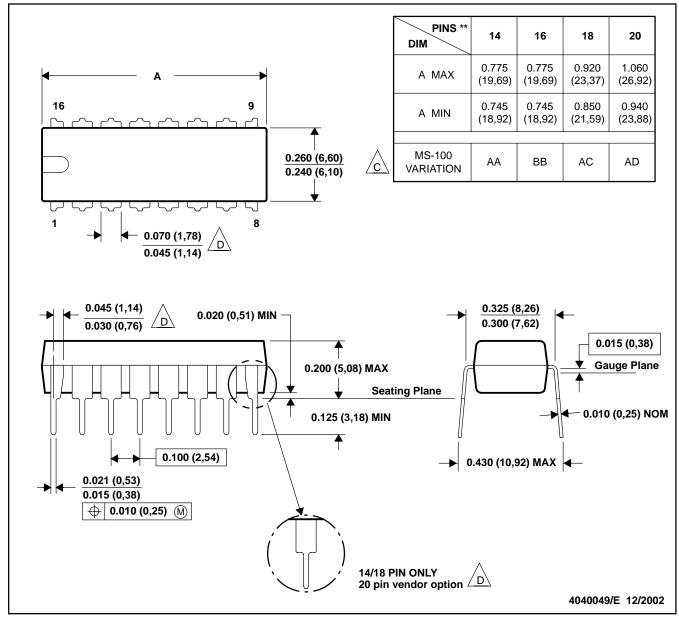
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MPDI002C - JANUARY 1995 - REVISED DECEMBER 20002

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

/д.

- B. This drawing is subject to change without notice.
- /C Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

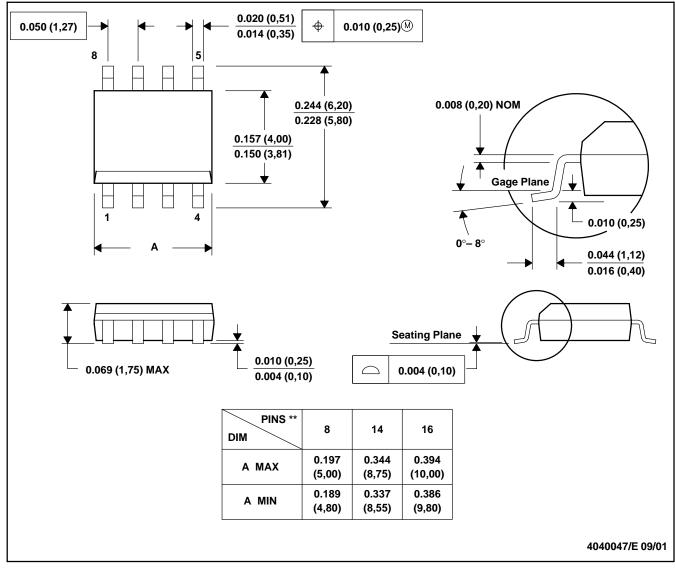


MECHANICAL DATA

MSOI002B - JANUARY 1995 - REVISED SEPTEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

D (R-PDSO-G**) 8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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